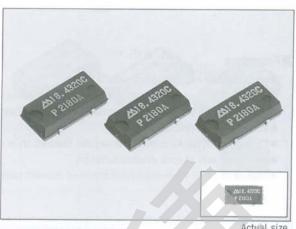
SMALL SMD TYPE HIGH FREQUENCY CRYSTAL OSCILLATOR

SG-636P

- · Small type SMD, thus allowing high density mounting
- Designed for universal purpose with built-in heat-resisting cylindrical type AT cut crystal and allowing almost the same temperature condition for soldering as SMD IC
- Height is 2.5mm
- Use of C-MOS IC enables reduction of current consumption
- Provided with output enable function



Actual size

■Specifications (characteristics)

Item		Symbol	Specifications	Remarks
Output frequency range		fo	2.2167MHz to 40.000MHz	
Power source voltage	MAX. supply voltage	$V_{\rm DD}$ + $V_{\rm SS}$	-0.5V to +7.0V	
	Operating voltage	V _{DD}	5.0V ±0.5V	
Temperature range	Storage temperature	T _{STG}	-55°C to +100°C	Stored without Tape and Reel
	Operating temperature	Tope	-10°C to +70°C	
Soldering condition		T _{SOL}	Under 260°C within 10 sec.×2 times or under 230°C within 3 min.	450
Frequency stability		∆f/fo	C: ±100ppm	-10°C to -70°C
Current consumption		I _{op}	16mA MAX.	No load condition
Duty		T _W /T	40% to 60% (45% to 55% ±1)	1/2 V _{tip} level
Output voltage		Von	V _{pp} -0.4V MIN,	I _{OH} = -2mA
		Vol	0.4V MAX.	I _{OL} =2mA
Output load condition		N	5LS TTL. MAX.	LSTTL load
		CL	15pF MAX.	C-MOS load
Output enable voltage		VIII	2.0V MIN.	- 11.00 t 1100t
		VII	0.8V MAX.	
Output disable current		I _{OE}	12mA MAX.	OE terminal=GND
Output rise time		tyun	7nsec.MAX.	Refer to output waveform chart (page 9)
Output fall time		triii	7nsec.MAX.	
Oscillation start time		tosc	10msec MAX.	More than for 1ms until V _{DD} =0V→4.5V. Time at 4.5V to be 0sec.
Aging		fa	±5ppm/year MAX.	Ta=25°C, V _{DD} =5V, first year
Shock resistance		S. R.	±20ppm MAX.	Drop test of 3 times on a hard board from 75cm height or excitation test with 3000G × 0.3ms × 1/2 sine wave in 3 direction

(Unit: mm)

Note • Unless otherwise stated, characteristics (specifications) shown in the above table are based on the rated operating temperature and voltage condition.

• The SG-636PT for a TTL load is also available. Please consult us. ※1 It is possible depending on condition, refer to reference data

External Dimensions

(1.0)

■View of recommended soldering pattern (Unit:mm)

